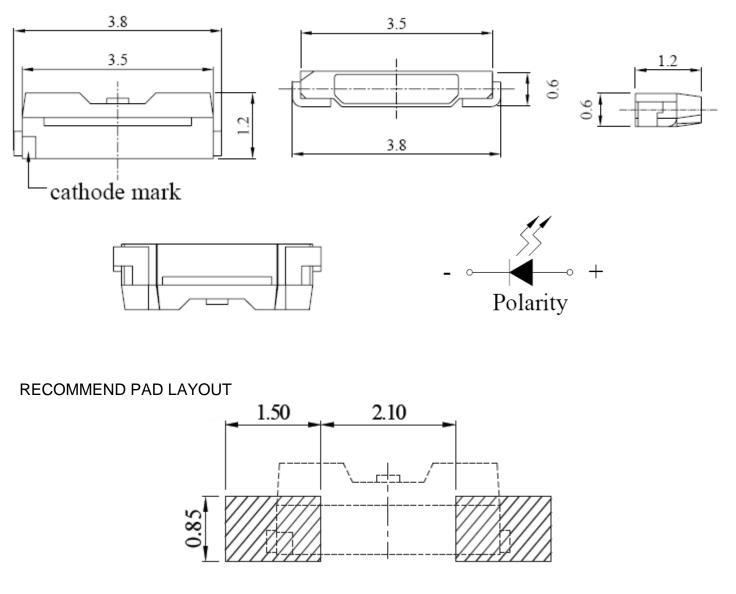


3.8 x 1.2 x 0.6 Green SMD, Tape and Reel

PACKAGE OUTLINES



NOTES:

1. All dimensions are in millimeters tolerance is ± 0.1 mm unless otherwise noted;

Part Number	Material	Lens Color		Lens Color	
	Wateria	Emitted	Lens		
L234NPGC-TR	InGaN	Green	Water Clear		



3.8 x 1.2 x 0.6 Green SMD, Tape and Reel

ABSOLUTE MAXIMUM RATINGS (Ta=25					
Parameter	Symbol	Ratings	Unit		
Reverse Voltage	Vr	5	V		
Forward Current	lf	30	mA		
Peak Forward Current (Duty 1/10@10ms)	lfp	100	mA		
Power Dissipation	Pd	120	mW		
Electrostatic Discharge	ESD	500	V		
Operating temperature range	Topr	-20~+80	°C		
Storage temperature range	Tstg	-30~+100	°C		
Soldering temperature range	Tsol	Reflow soldering: 260°C Hand soldering: 350°C			

OPTICAL-ELECTRICAL CHARACTERISTICS

(Ta=25°C)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Luminous Intensity	lv		320		1250	mcd
Dominant Wavelength	λD		519		531	nm
Spectral Radiation Bandwidth	Δλ	I _F =20mA		30		nm
Forward Voltage	Vf		2.8		4.0	V
Viewing Angle	20 1⁄2			120		Deg
Reverse Current	Ir	V _R =5V			50	μA

Note: 1. Tolerance of luminous intensity: ±15%

2. Tolerance of dominant wavelength: ±1nm

3. Tolerance of forward voltage: ±0.05V



3.8 x 1.2 x 0.6 Green SMD, Tape and Reel

BIN RANGE OF LUMINOUS INTENSITY

Bin	Min	Мах	Unit	Condition
Т	320	500	- mcd	I _F =20mA
U	500	800		
V-1	800	1000		
V-2	1000	1250		

BIN RANGE OF DOMINANT WAVELENGTH

Bin Code	Min	Мах	Unit	Condition
10	519	522	- nm	I _F =20mA
1P	522	525		
1Q	525	528		
R	528	531		

BIN RANGE OF FORWARD VOLTAGE

Bin Code	Min	Мах	Unit	Condition
1	2.8	3.0	V	I _F =20mA
2	3.0	3.2		
3	3.2	3.4		
4	3.4	3.6		
5	3.6	3.8		
6	3.8	4.0		



3.8 x 1.2 x 0.6 Green SMD, Tape and Reel

TYPICAL ELECTRO-OPTICAL CHARACTERISTIC CURVES

Fig.1 Forward current vs. Forward Voltage

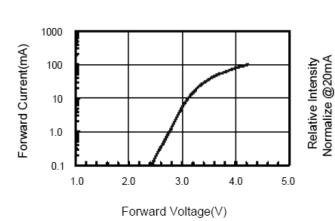
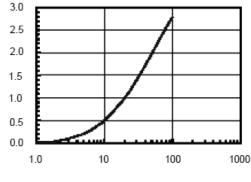




Fig.2 Relative Intensity vs. Forward Current



Forward Current(mA)



Fig.4 Relative Intensity vs. Temperature

3.0

2.5

2.0

1.5 1.0

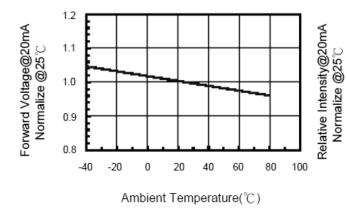
0.5

0.0

-40

-20

0





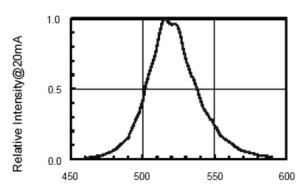


Fig.6 Directive Radiation

20

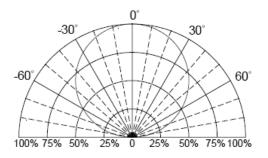
40

Ambient Temperature(°C)

60

80

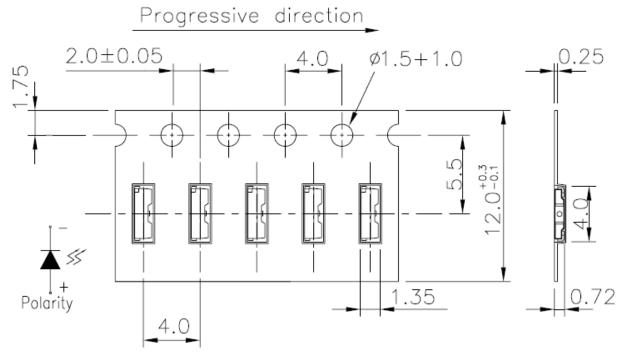
100





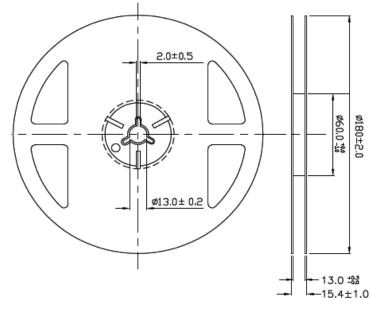
3.8 x 1.2 x 0.6 Green SMD, Tape and Reel

CARRIER TAPE DIMENSION



Note: The tolerances unless mentioned are ±0.1mm, Angle ±0.5; Unit=mm

REEL DIMENSIONS



Notes:
1. 3000 pieces per reel
2. Tolerance unless mentioned is ±0.1mm; Unit=mm
Version 2.0 Date: 2-28-2013 Specifications are subject to change without notice.

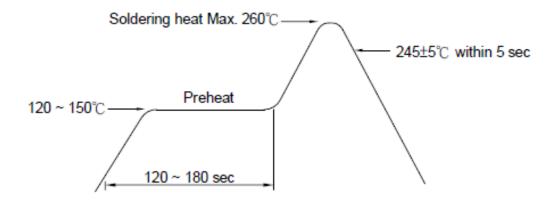
American Opto Plus LED Corp. 1206 E. Lexington Ave., Pomona CA 91766 Tel: 909-465-0080 Fax: 909-465-0130 www.aopled.com



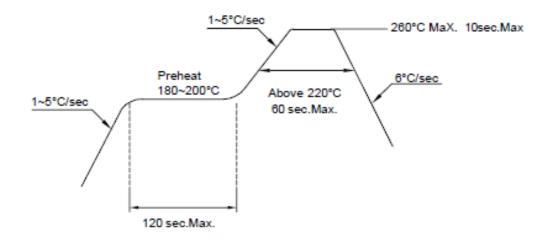
3.8 x 1.2 x 0.6 Green SMD, Tape and Reel

PRECAUTIONS FOR USE

- Hand solder Basic spec is ≤ 320°C 3 sec one time only.
- 2. Wave solder



3. PB-Free reflow solder



Notes:

- 1. Reflow soldering should not be done more than two times.
- 2. When soldering, do not put stress on the LEDs during heating.
- 3. After soldering, do not warp the circuit board.



3.8 x 1.2 x 0.6 Green SMD, Tape and Reel

PRECAUTIONS FOR USE:

Storage Time:

1. The operation of temperatures and RH are: 5°C~35°C, RH60%.

2. Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp proof box with descanting agent. Considering the tape life, we suggest our customers to use our products within a year (from production date).

3. If opened more than one week in an atmosphere 5°C~35°C, RH60%, they should be treated at 60°C±5°C for 15hrs.

Drive Method:

LED is a current operated device, and therefore, require some kind of current limiting incorporated into the driver circuit. This current limiting typically takes the form of a current limiting resistor placed in a series with the LED.

Consider worst case voltage variations that could occur across the current limiting resistor. The forward current should not be allowed to change by more than 40% of its desired value.



(A) Recommended circuit.

(B) The difference of brightness between LED could be found due to the VF-IF characteristics of LED.

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED.

ESD(Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or antielectrostatic glove is recommended when handling these LEDs. All devices and machinery must be properly grounded.



3.8 x 1.2 x 0.6 Green SMD, Tape and Reel

RELIABILITY TEST

1. Test items and results

Classification	Test Item	Test Condition	Sample Size
	Operating Life Test	1.Ta=Under Room Temperature As Per Data Sheet Maximum Rating. 2.If=20mA 3.t=1000 hrs	22
Endurance Test	High Temperature Storage Test	1.Ta=105℃±5℃ 2.t=500 hrs	22
	Low Temperature Storage Test	1.Ta=-40℃±5℃ 2.t=1000 hrs	22
	High Temperature High Humidity Storage Test	1.IR-Reflow In-Board, 2 Times 2.Ta=85℃±5℃ 3.RH=90%~95% 4.t=500hrs±2hrs	22
	Thermal Shock Test	1.IR-Reflow In-Board,2 times 2.Ta=105℃±5℃ & -40℃±5℃ (30min) (30min) 3.total 100 cycles	22
Environmental Test	Reflow Soldering Test	1.T.Sol=260℃±5℃ 2.Dwell Time= 10Max.	22
	Temperature Cycling	1.105℃ ~ 25℃ ~ -40℃ 30mins 15mins 30mins 2.100 Cyeles	22

2. Criteria for judging the damage

Item	Symbol	Test Conditions	Criteria for Judgement		
	Symbol		Min.	Max.	
Forward Voltage	Vf	lf=20mA	-	U.S.L x1.2	
Reverse Current	Ir	Vr=5V	-	U.S.L x2.0	
Luminous Intensity	Iv	lf=20mA	L.S.L x 0.5	-	

Note:

- 1. U.S.L.: Upper Standard Level
- 2. L.S.L.: Lower Standard Level